PCN Number:	20190626004.0		PCN Date:	July 29, 2019			
Title: Datasheet for TPS7B82-Q1							
Customer Contact:	PCN Manager Quality Services				Quality Services		
Change Type:							
Assembly Site	Design					r Bump Site	
		Data Sheet				r Bump Material	
Assembly Materials		Part number change			Wafer Bump Process		
		Test Site			Wafer Fab Site Wafer Fab Materials		
Packing/Shipping/Labeling Test P		Test Proce	est Process		Wafer Fab Process		
Notificat			n Details				
Notification Details Description of Change:							
Texas Instruments Inco The product datasheet(The following change hi TEXAS	s) is being upd	ated as sur	nmarized below		inicati	on. TPS7B82-Q1	
	0-4-k 2040) 4 D			SLVSDC	0E-NOVE	MBER 2017-REVISED JUNE 2019	
Changes from Revision D (Page	
Added KVU package to document as Preview device							
-						1	
 Added TO-252 sub-bullet and added R_{BJA} values for HVSSOP and WSON sub-bullets in <i>Packages</i> bullet							
Added KVU to Pin Configuration and Functions section							
Changed <i>Electrical Characteristics</i> table							
Added second column in	lest Conditions to c	all out device p	backage differences	S			
The datasheet number w	vill be changing						
Device Family			Change F	Change From:		Change To:	
TPS7B82-Q1			SLVSDQ0	SLVSDQ0D		SLVSDQ0E	
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TPS7B82-Q1							
Reason for Change:							
To accurately reflect device characteristics.							
Anticipated impact of	n Fit, Form, Fu	unction, Q	uality or Reli	ability	(pos	itive / negative):	
No anticipated impact. the actual device.	This is a specifi	cation char	ige announcen	nent o	nly. Th	ere are no changes to	
Changes to product identification resulting from this PCN:							
None.							
Product Affected:							
TPS7B8233QDGNRQ1	TPS7B8233QI	DRVRQ1	TPS7B8250QD	GNRQ1	. 1	PS7B8250QDRVRQ1	
				-	L	_	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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